



SM55J Series 1.8 V CMOS Clock Oscillators

January 2016



- Pletronics' SM55J Series is a quartz crystal controlled precision square wave generator with a CMOS output.
- The package is designed for high density surface mount designs.
- This is a low cost mass produced oscillator.
- Tape and Reel or cut tape packaging is available.
- 40 to 135 MHz
- 3.2 x 5 mm LCC Ceramic Package
- Enable/Disable Function
- Disable function includes low standby power mode
- 3rd Overtone Crystals used
- Low Jitter

Pletronics Inc. certifies this device is in accordance with the RoHS 6/6 (2011/65/EC) and WEEE (2002/96/EC) directives.

Pletronics Inc. guarantees the device does not contain the following:
 Cadmium, Hexavalent Chromium, Lead, Mercury, PBB's, PBDE's
 Weight of the Device: 0.064 grams
 Moisture Sensitivity Level: 1 As defined in J-STD-020C
 Second Level Interconnect code: e4

Absolute Maximum Ratings:

Parameter	Unit
V _{CC} Supply Voltage	-0.3V to +4.0V
V _i Input Voltage	-0.3V to V _{CC} + 0.3V
V _o Output Voltage	-0.3V to V _{CC} + 0.3V
I _o Output Current	+20 mA to -20 mA

Thermal Characteristics

The maximum die or junction temperature is 125°C
 The thermal resistance junction to board is 30 to 50°C/Watt depending on the solder pads, ground plane and construction of the PCB.

Part Number:

SM55	45	J	E	X	- 75.0M	-XX	
							Packaging code or blank T250 = 250 per Tape and Reel T500 = 500 per Tape and Reel T1K = 1000 per Tape and Reel
							Frequency in MHz
							Supply Voltage V_{CC} X = 1.8V ± 10%
							Optional Enhanced OTR Blank = Temp. range -10 to +70°C C = Temp. range -20 to +70°C E = Temp. range -40 to +85°C
							Series Model
							Frequency Stability 45 = ± 50 ppm 44 = ± 25 ppm 20 = ± 20 ppm
							Series Model

Part Marking and Legend:

P ff.fff M • YMDxx	P ff.fff M • YYWWxx	PLE SM55 ff.fff M • YMDxx	P5xYWWx • ff.fff M	5xYWWxx ff.fff M • PLExx
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PLE = Pletronics
 ff.fff M or ff.ff M = Frequency in MHz
 YYWW or YWW or YMD = Date of Manufacture (year and week, or year-month-day)
 All other marking is internal factory codes

Specifications such as frequency stability, supply voltage and operating temperature range, etc. are not identified from the marking. External packaging labels and packing list will correctly identify the ordered Pletronics part number.

Codes for Date Code YMD

Code	4	5	6	7	8	Code	A	B	C	D	E	F	G	H	J	K	L	M
Year	2014	2015	2016	2017	2018	Month	JAN	FEB	MAR	APR	MAY	JUN	JUL	AUG	SEP	OCT	NOV	DEC

Code	1	2	3	4	5	6	7	8	9	A	B	C	D	E	F	G
Day	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16
Code	H	J	K	L	M	N	P	R	T	U	V	W	X	Y	Z	
Day	17	18	19	20	21	22	23	24	25	26	27	28	29	30	31	

Electrical Specification for 1.80V $\pm 10\%$ over the specified temperature range

Item	Min	Typ	Max	Unit	Condition
Frequency Range	40		135	MHz	
Frequency Accuracy	"45"	-50	+50	ppm	For all supply voltages, load changes, aging for 1 year, shock, vibration and temperatures
	"44"	-25	+25		
	"20"	-20	+20		
Output Waveform	CMOS				
Output High Level	$V_{CC}-0.4$		-	V	
Output Low Level	-		0.4	V	
Output Symmetry	45		55	%	at 50% point of V_{CC} (See load circuit)
Phase Noise	10 Hz	-	-78	-	dBc/Hz at 25 °C, 125 MHz typical
	100 Hz	-	-107	-	
	1 kHz	-	-132	-	
	10 kHz	-	-144	-	
	100 kHz	-	-151	-	
	1 MHz	-	-155	-	
	10 MHz	-	-158	-	
Enable/Disable Internal Pull-up	30		-	Kohm	to V_{CC}
V disable	-		30	%	of V_{CC} applied to pad 1
V enable	70		-	%	
Output leakage	$V_{OUT} = V_{CC}$	-10	+10	uA	Pad 1 low, device disabled
	$V_{OUT} = 0V$	-10	+10	uA	
Standby Current I_{CC}	-		10	uA	
Disable time	-		200	nS	Time for output to reach a high Z state
Start up time	-		10	mS	Time for output to reach specified frequency
Operating Temperature Range	-10		+70	°C	Standard Temperature Range
	-20		+70	°C	Extended Temperature Range "C"
	-40		+85	°C	Extended Temperature Range "E"
Storage Temperature Range	-55		+125	°C	
Output Load Capacitance (Cl)	-		15	pF	

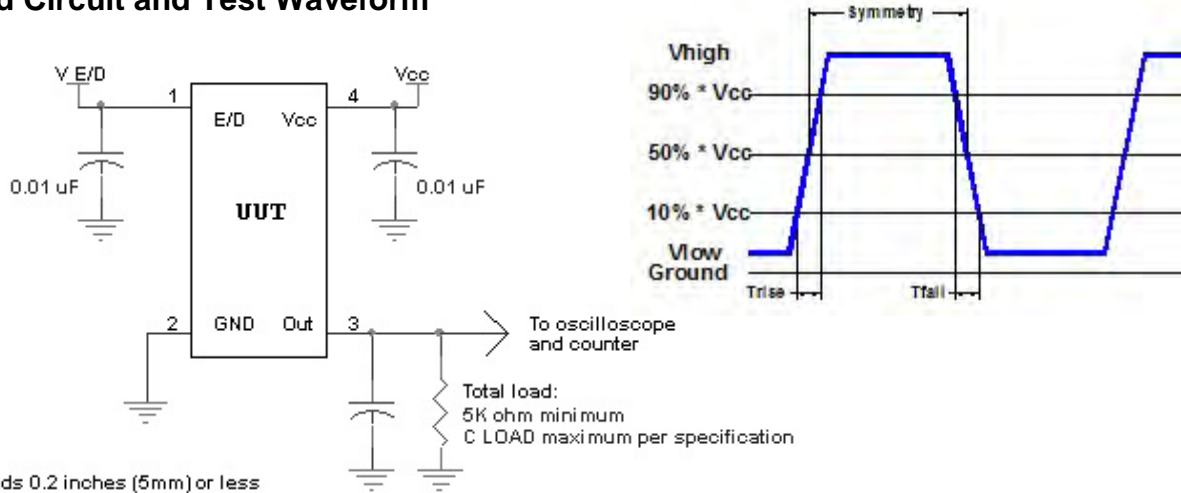
A 0.01 nF or larger capacitor mounted proximal to the device between V_{CC} and V_{SS} is required.

Electrical Specification for 1.80V \pm 10% over the specified temperature range

Item	Min	Typ	Max	Unit	Condition	
Output T _{RISE} and T _{FALL}	-	1.5	2.5	nS	C _{LOAD} = 15 pF 10% to 90% of V _{CC} See Load Circuit	
V _{CC} Supply Current (I _{CC})	-	2.5	5.0	mA	50 MHz	no load
	-	2.5	5.0	mA	65 MHz	
	-	3.5	7.0	mA	85 MHz	
	-	4.0	7.5	mA	100 MHz	
	-	4.5	8.5	mA	133 MHz	

Specifications with Pad 1 E/D open circuit

Load Circuit and Test Waveform



All leads 0.2 inches (5mm) or less

Reliability: Environmental Compliance

Parameter	Condition
Mechanical Shock	MIL-STD-883 Method 2002, Condition B
Vibration	MIL-STD-883 Method 2007, Condition A
Solderability	MIL-STD-883 Method 2003
Thermal Shock	MIL-STD-883 Method 1011, Condition A

ESD Rating

Model	Minimum Voltage	Conditions
Human Body Model	1500	MIL-STD-883 Method 3115
Charged Device Model	1000	JESD 22-C101

Package Labeling

Label is 1" x 2.6" (25.4mm x 66.7mm)

Font is Courier New

Bar code is 39-Full ASCII

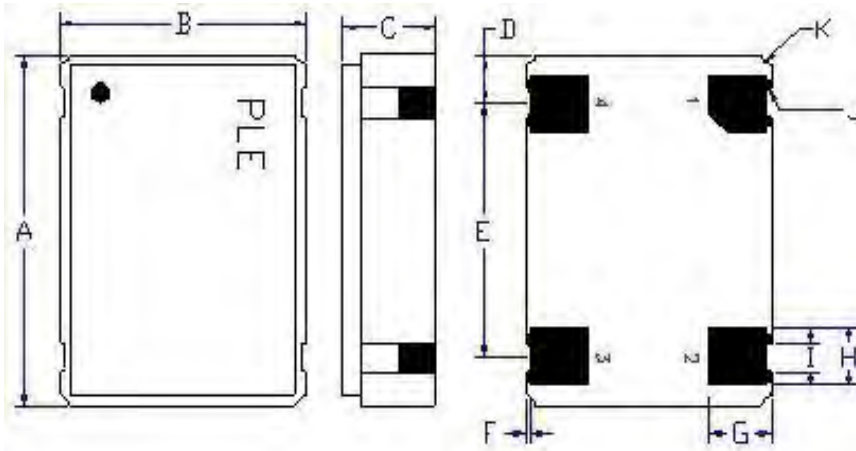
Label is 1" x 2.6" (25.4mm x 66.7mm)

Font is Arial

P/N:	
	SM5545JEX-125.0M
Customer P/N:	
	12345678
Qty:	
	1000
D/C	
	0JX-MTG
MSL: 1	

RoHS Compliant
2nd LvL Interconnect
Category=e4
Max Safe Temp=260C for 10s 2X Max

Mechanical:



	Inches	mm
A	0.197 ±0.006	5.00 ±0.15
B	0.126 ±0.006	3.20 ±0.15
C	0.045 ±0.004	1.15 ±0.10
D ¹	0.048	1.23
E ¹	0.100	2.54
F ¹	0.004	0.10
G ¹	0.050	1.27
H ¹	0.055	1.40
I ¹	0.024	0.60
J ¹	0.004	0.10R
K ¹	0.008	0.020R

Not to Scale

¹ Typical dimensions

Contacts :

Gold 11.8 to 39.4 μinches (0.3 to 1.0 μm) over Nickel 50 to 350 μinches (1.27 to 8.89 μm)

Pad	Function	Note
1	Output Enable/Disable	When this pad is not connected the oscillator shall operate. When this pad is logic low the output will be inhibited (high impedance state.) Recommend connecting this pad to V _{CC} if the oscillator is to be always on.
2	Ground (GND)	
3	Output	
4	Supply Voltage (V _{CC})	Recommend connecting appropriate power supply bypass capacitors as close as possible.

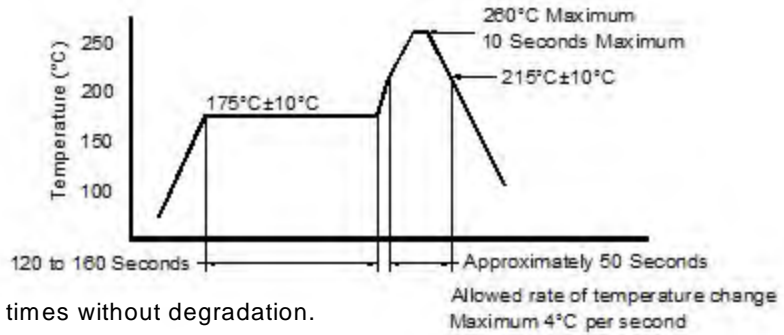


Layout and application information

For Optimum Jitter Performance, Pletronics recommends:

- a ground plane under the device
- no large transient signals (both current and voltage) should be routed under the device
- do not layout near a large magnetic field such as a high frequency switching power supply
- do not place near piezoelectric buzzers or mechanical fans.

Reflow Cycle (typical for lead free processing)



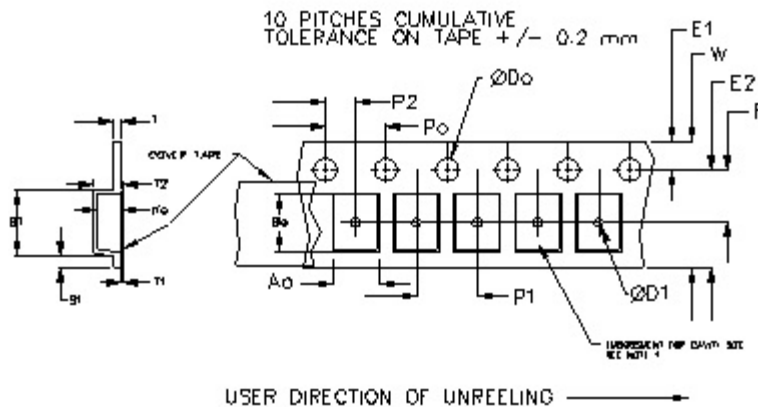
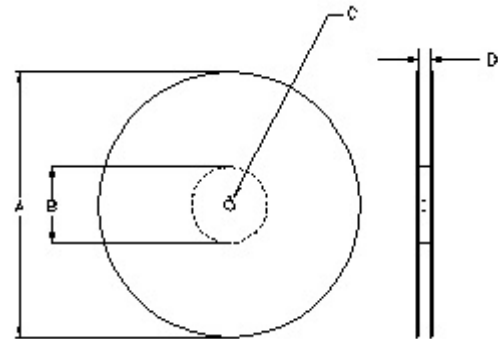
The part may be reflowed 3 times without degradation.

Tape and Reel: available for quantities of 250 to 1000 per reel, cut tape for < 250

Constant Dimensions Table 1								
Tape Size	D0	D1 Min	E1	P0	P2	S1 Min	T Max	T1 Max
8mm	1.5	1.0	1.75	4.0	2.0 ± 0.05	0.6	0.6	0.1
12mm		1.5			2.0 ± 0.1			
16mm	+0.1 -0.0	1.5	± 0.1	± 0.1	2.0 ± 0.1			
24mm		1.5						

Variable Dimensions Table 2							
Tape Size	B1 Max	E2 Min	F	P1	T2 Max	W Max	Ao, Bo & Ko
16 mm	12.1	14.25	7.5 ± 0.1	8.0 ± 0.1	8.0	16.3	Note 1

Note 1: Embossed cavity to conform to EIA-481-B Dimensions in mm Not to scale



		REEL DIMENSIONS			Tape Width
A	inches	7.0	10.0	13.0	
	mm	177.8	254.0	330.2	
B	inches	2.50	4.00	3.75	
	mm	63.5	101.6	95.3	
C	mm	13.0 +0.5 / -0.2			
D	mm	16.4 +2.0 -0.0	16.4 +2.0 -0.0	16.4 +2.0 -0.0	16.0

Reel dimensions may vary from the above